

CLAIMS

1. A mount structure for thermal fuse on circuit board, comprising:
a circuit board having one surface where a predetermined circuit is
5 formed;
a through opening provided in said circuit board;
Sub A: an electronic component attached to the one surface of said circuit
board to extend across said through opening; and
a thermal fuse provided on the other surface of said circuit board to
10 enter said through opening, responding to temperature of said electronic
component via a heat-conducting insulating member filling said through
opening for breaking said predetermined circuit.
2. The mount structure for thermal fuse on circuit board according
15 to claim 1, wherein
said heat-conducting insulating member is silicone resin.
3. The mount structure for thermal fuse on circuit board according
to claim 1, including a through hole provided in said circuit board, wherein
20 said thermal fuse is electrically connected to said predetermined
circuit via said through hole.
4. The mount structure for thermal fuse on circuit board according
to claim 1, wherein
25 said thermal fuse includes therein a rod-shaped fuse.